### PATENT COOPERATION TREATY

## **PCT**

REC'D 28 JUN 2005

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# INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY (Chapter II of the Patent Cooperation Treaty)

(PCT Article 36 and Rule 70)

#### INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

International application No.

PCT/SE2004/000439

Box	No. I	Basis of the report			
1.	With regard to the language, this report is based on the international application in the language in which it was filed, unle otherwise indicated under this item.				
		This report is based on a translation from the original language into the following language, which is the language of a translation furnished for the purposes of:			
		international search (under Rules 12.3 and 23.1(b))			
		publication of the international application (under Rule 12.4)			
		international preliminary examination (under Rules 55.2 and/or 55.3)			
2.	2. With regard to the elements of the international application, this report is based on (replacement sheets we furnished to the receiving Office in response to an invitation under Article 14 are referred to in this report as and are not annexed to this report):				
		the international application as originally filed/furnished			
	$\boxtimes$	the description:			
		pages 1-12 as originally filed/furnished			
		pages* received by this Authority on			
		pages* received by this Authority on			
	$\boxtimes$	the claims:			
		pages 13-16 as originally filed/furnished			
		pages* as amended (together with any statement) under Article 19			
		pages* 16a received by this Authority on 2005-05-17 pages* received by this Authority on			
	<b>NZI</b>				
	M	the drawings:			
		pages 1-15 as originally filed/furnished pages* received by this Authority on			
		pages* received by this Authority on			
	$\Box$	a sequence listing and/or any related table(s) – see Supplemental Box Relating to Sequence Listing.			
		a sequence fishing and/or any related table(s) – see Supplemental Box Relating to Sequence Listing.			
3.	The amendments have resulted in the cancellation of:				
		the description, pages			
		the claims, Nos.			
		the drawings, sheets/figs			
		the sequence listing (specify):			
		any table(s) related to the sequence listing (specify):			
4.		This report has been established as if (some of) the amendments annexed to this report and listed below had not been made, since they have been considered to go beyond the disclosure as filed, as indicated in the Supplemental Box (Rui 70.2(c)).			
		the description, pages			
		the claims, Nos.			
		the drawings, sheets/figs			
		the sequence listing (specify):			
		any table(s) related to the sequence listing (specify):			
*	If item	4 applies, some or all of those sheets may be marked "superseded."			

#### INTERNATIONAL PRELIMINARY REPORT ON PATENTABILITY

International application No.

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Box No. V	Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement				
1. Statemen	nt	-			
Nove	elty (N)	Claims Claims	1-25	YES NO	
Inve	ntive step (IS)	Claims Claims	1-25	YES NO	
Indu	strial applicability (IA)	Claims Claims	1-25	YES NO	

2. Citations and explanations (Rule 70.7)

Documents cited in the International Search Report:

D1: US6002177 A

D2: US2003022475 A1

D3: EP0926726 A1

The cited documents represent the general state of the art.

The invention defined in claims 1-25 is not disclosed by any of these documents.

The cited prior art does not give any indication that would lead a person skilled in the art to the claimed method of making an insulated electric connection between a first and a second surface of a conducting or semi-conducting wafer. Therefore, the claimed invention is not obvious to a person skilled in the art.

Accordingly, the invention defined in claims 1-25 is novel and is considered to involve an inventive step. The invention is industrially applicable.

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Box No. VIII	Certain observations on the international application

The following observations on the clarity of the claims, description, and drawings or on the question whether the claims are fully supported by the description, are made:

The referring claim in claim 20-24 is probably wrong. They should probably refer to claim 17 instead of claim 16.



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#### NEW CLAIM SUBMITTED IN RESPONSE TO WRITTEN OPINION:

25. A Micro-Electrical-Mechanical System (MEMS) device, comprising solder bumps for flip-chip mounting placed on the backside of the device, and having wafer through electrical interconnections (vias, 12), wherein the electrical interconnections (12) are insulated from surrounding material of the wafer by a finite layer (15) of an insulating material, wherein the material of the interconnections comprises the same material as the wafer, i.e. it is made from the wafer material.